© Copyright 2005. IPC, Ba	© Convright 2005 IPC Bannockburn Illinois All rights reserved under both				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				als and Mfg Information				
Supplier Information												
Company name* Company unique ID				Unique ID Authority				Response Date*				
semi								2025-08-23				
Contact Name	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	s Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number M	Ifr Item Number	Mfr Item Name		Effective D	ate Version	ı	Manufacturing Site		eight*	UOM	Unit Type	
N	CP51403MNTXG 3 Amp VTT Termin DDR2, DDR3, LPE		ination Regulator DDR1 DDR3, DDR4	, 2025-08-23			MY1	25	5.0	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Array Material Terminal Base Alloy J-		-STD-020 MSL Rating	Peak Process Body Temperature Max Time at Pe			ure Max Time at Peak	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy 1			260		С	30	seconds	s 3				
Comments												
level 1 - maximum time at peak temperature du	ring soldering is 10-3	0 seconds										
For more information regarding material compo	osition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or en a [F] Optionally enter the positive (+) a				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.52	mg	Supplier	Silicon (Si)	7440-21-3		1.52	mg
Die Attach	0.22	mg	Supplier	Silver (Ag)	7440-22-4		0.165	mg
			Supplier	Epoxy resins	129915-35-1		0.055	mg
Lead Frame	10.17	mg	Supplier	Silver (Ag)	7440-22-4		0.1017	mg
			Supplier	Tin (Sn)	7440-31-5		0.0254	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0224	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0254	mg
			Supplier	Copper (Cu)	7440-50-8		9.9951	mg
Mold Compound-Black	12.43	mg		Epoxy resin	proprietary data		0.5842	mg
			Supplier	Phenol Resin	Proprietary Data		0.5842	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0124	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.2492	mg
Plating	0.47	mg	Supplier	Tin (Sn)	7440-31-5		0.47	mg
Wire Bond - Au	0.19	mg	Supplier	Gold (Au)	7440-57-5		0.19	mg